EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	19	((junction and hot and cold) with temperature with sensor) same (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 15:16
L2	22	CPU and ((junction and hot and cold) with temperature with sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 15:18
L3	128	(die ir semiconductor or processor or microprocessor or IC or (integrated adj circuit)) and ((junction and hot and cold) with temperature with sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 15:20
L4	123	(die or semiconductor or processor or microprocessor or IC or (integrated adj circuit)) and ((junction and hot and cold) with temperature with sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 15:20
L5	223	(thermoelectric$2 or peltier) same (heat adj sink) and (temperature with (chip and sink))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 15:26
L6	94	5 and fan	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 15:27
L7	10	("3097027" | "3615870" | "3635037" | "3663307" | "4859250" | "5022928" | "5610366" | "5724818" | "6384312").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 15:37
L8	38	("4685081" | "4704872" | "5028988" | "5032897" | "5065085" | "5079618").PN. OR ("5569950").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 15:42
L9	2052	(361/687,695,697,700).CCLS.	US-PGPUB	OR	OFF	2008/10/31 16:04
L10	1807	(165/80.3,80.4,104.33,185).CCLS.	US-PGPUB	OR	OFF	2008/10/31 16:04
L11	290	(700/79,299,300).CCLS.	US-PGPUB	OR	OFF	2008/10/31 16:04
L12	202	(219/497,499,505).CCLS.	US-PGPUB	OR	OFF	2008/10/31 16:04
L13	389	(257/712).CCLS.	US-PGPUB	OR	OFF	2008/10/31 16:04
L14	291	(62/3.3,3.6,3.7).CCLS.	US-PGPUB	OR	OFF	2008/10/31 16:05

L16	1	10 and (thermoelectric$2 or peltier) same fan same (junction with temperature)	US-PGPUB	OR	ON	2008/10/31 16:07
L17	0	11 and (thermoelectric$2 or peltier) same fan same (junction with temperature)	US-PGPUB	OR	ON	2008/10/31 16:07
L18	0	12 and (thermoelectric$2 or peltier) same fan same (junction with temperature)	US-PGPUB	OR	ON	2008/10/31 16:07
L19	0	13 and (thermoelectric$2 or peltier) same fan same (junction with temperature)	US-PGPUB	OR	ON	2008/10/31 16:07
L20	0	14 and (thermoelectric$2 or peltier) same fan same (junction with temperature)	US-PGPUB	OR	ON	2008/10/31 16:07
L21	20	14 and (thermoelectric$2 or peltier) and fan and (junction with temperature)	US-PGPUB	OR	ON	2008/10/31 16:08
L22	2	13 and (thermoelectric$2 or peltier) and fan and (junction with temperature)	US-PGPUB	OR	ON	2008/10/31 16:10
L23	0	12 and (thermoelectric$2 or peltier) and fan and (junction with temperature)	US-PGPUB	OR	ON	2008/10/31 16:10
L24	0	11 and (thermoelectric$2 or peltier) and fan and (junction with temperature)	US-PGPUB	OR	ON	2008/10/31 16:10
L25	5	10 and (thermoelectric$2 or peltier) and fan and (junction with temperature)	US-PGPUB	OR	ON	2008/10/31 16:11
S2	1	("4685081").PN.	USPAT	OR	OFF	2008/10/31 09:08
S3	1	CPU same (junction with temperature with sensor) same (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 09:11
S4	1	(microprocessor or processor) same (junction with temperature with sensor) same (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 09:12
S5	1073	(microprocessor or processor or cpu) and (junction with temperature with sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 09:13
S6	181	S5 and (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 09:20

S7	9	("20010029740" | "20020092307" | "4631728" | "4935864" | "5088098" | "5569950" | "6198245" | "6400045" | "6588217").PN. OR ("7185500").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 09:33
S8	38	("4685081" | "4704872" | "5028988" | "5032897" | "5065085" | "5079618").PN. OR ("5569950").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 09:38
S9	25	("4812733" | "4926227" | "4975766" | "4982274" | "5361188" | "5440520" | "5483102" | "5569950").PN. OR ("5831333").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 09:42
S10	27	("4238759" | "4351005").PN. OR ("4685081").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 09:50
S11	26	("2846592" | "2915724" | "2941153" | "3017522" | "3460008" | "3495141" | "3502518" | "3504240").PN. OR ("4238759").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 09:53
S12	17	("4058744" | "4238759" | "4409662" | "4658081" | "4716551").PN. OR ("5603570").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 09:59
S13	9	("5385022" | "5457342" | "5515682" | "5946188" | "6055814" | "6173576" | "6196003" | "6234240" | "6581388").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 10:03
S14	1	("5931580").URPN.	USPAT	OR	ON	2008/10/31 10:07
S15	6759	(microprocessor or processor or cpu) and ((interior or integral or inside) with temperature with sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 10:12
S16	796	(microprocessor or processor or cpu) with ((interior or integral or inside) with temperature with sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 10:12
S17	37	S16 and (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 10:12
S18	3	("2003/0117760").URPN.	USPAT	OR	ON	2008/10/31 10:14
S19	15	("5419780" | "5422787" | "5501076" | "5737923" | "5986883" | "6173576" | "6345507" | "6452797" | "6671177" | "6717811" | "6723917").PN. OR ("6822861").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 10:15

S20	58	("2083611" | "2947150" | "3205667" | "3821881" | "3823567" | "3990862" | "4007600" | "4093755" | "4312012" | "4326383" | "4353415" | "4472945" | "4586342" | "4726193" | "4744220" | "4787442" | "4829771" | "4833567" | "4833888" | "4855810" | "4966226" | "4989626" | "4995451" | "5064476" | "5154661" | "5206791" | "5209069" | "5253702" | "5308920" | "5343940" | "5367890").PN. OR ("5737923").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 10:16
S21	141	(IC or die)with (junction with temperature with sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 10:20
S22	37	S21 and (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 10:20
S23	426	(semiconductor or chip) with (junction with temperature with sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 10:27
S24	473	(semiconductor or chip or (integrated adj circuit)) with (junction with temperature with sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 10:27
S25	77	S24 and (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 10:28
S26	2	("2002/0190337").URPN.	USPAT	OR	ON	2008/10/31 10:34
S27	6	(microprocessor or processor or die or chip or semiconductor or IC) same (within ir integral) with (junction with temperature with (sensor or sensing)) same (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 10:42
S28	4	(microprocessor or processor or die or chip or semiconductor or IC) same (within or integral) with (junction with temperature with (sensor or sensing)) same (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 10:46
S29	70	(microprocessor or processor or die or chip or semiconductor or IC) same (within or integral) with (junction with temperature with (sensor or sensing))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 10:46

S30	14	("20040062293" | "5195827" | "6097239" | "6133753" | "6149299" | "6169442" | "6188189" | "6255973" | "6332710" | "6528987" | "6554470" | "6637934" | "6679628" | "6808307").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 10:52
S31	24	("5639163" | "5710519" | "6055489").PN. OR ("6169442").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 10:58
S32	43	("4071813" | "4243898" | "4448549" | "4625128" | "4760434" | "4768170" | "4791380" | "4875131" | "4952865" | "5024535" | "5039878" | "5094546" | "5154514" | "5206778" | "5213416" | "5237481").PN. OR ("5639163").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 11:01
S33	57	("3383614" | "3480852" | "3502944" | "3521167" | "3622849" | "3651379" | "3688295" | "3906310" | "3931619" | "4001649" | "4039928" | "4117527" | "4330809" | "4522512" | "4669025" | "4689659" | "4696578" | "4734641" | "4823290" | "4840495" | "4896199" | "4896245" | "4907117" | "4970497" | "5008736" | "5119265" | "5206778" | "5230055" | "5230074" | "5245510" | "5287292" | "5291607" | "5383083" | "5406212" | "5422806" | "5422832" | "5477417" | "5539381" | "5555152" | "5600575" | "5618459" | "5639163" | "5664201" | "5673176" | "5712802" | "5726603" | "5763929" | "5863814" | "5940784" | "5997174" | "6039471" | "6092926" | "6106149").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 11:06
S34	23	("3521167" | "3622849" | "3906310" | "4039928" | "4418339" | "4538199" | "4667265" | "4669026" | "4891729" | "4896199" | "4907117").PN. OR ("5206778").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 11:14
S35	16	("3885200" | "3932849" | "4001649" | "4157513" | "4329725" | "4381480").PN. OR ("4669025").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 11:23
S36	71	("3851528" | "4165642" | "4277975" | "4875783" | "4918505" | "4943559" | "5024535" | "5159520" | "5295746" | "5419637" | "5639163" | "5655305").PN. OR ("5961215").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 11:33
S37	28	("3622849").URPN.	USPAT	OR	ON	2008/10/31 11:49
S38	5	("3564293" | "3622849" | "4001649" | "4052744" | "5249141").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/10/31 11:50
S39	0	(microprocessor or processor or die or chip or semiconductor or IC) same (buil-in or (on-chip) or embedded) with (junction with temperature with (sensor or sensing)) same (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 11:53

S40	0	(microprocessor or processor or die or chip or semiconductor or IC) same (built-in or (on-chip) or embedded) with (junction with temperature with (sensor or sensing)) same (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 11:53
S41	0	(microprocessor or processor or die or chip or semiconductor or IC) same ((built-in) or (on-chip) or embed$1ed) with (junction with temperature with (sensor or sensing)) same (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 11:54
S42	27	(microprocessor or processor or die or chip or semiconductor or IC) same ((built-in) or (on-chip) or embed$1ed) with (junction with temperature with (sensor or sensing))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 11:54
S43	1	(microprocessor or processor or die or chip or semiconductor or IC) same ((built-in) or (on-chip) or embed$1ed) with (junction with temperature) same (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 11:56
S44	4	(microprocessor or processor or die or chip or semiconductor or IC) and ((built-in) or (on-chip) or embed$1ed) with (junction with temperature) same (thermoelectric$2 or Peltier)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 11:56
S45	1	("20050174737").PN.	US-PGPUB	OR	OFF	2008/10/31 12:05
S46	1073	(microprocessor or processor or cpu) and (junction with temperature with sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 12:10
S47	2	S46 and (thermoelectric$2 or Peltier) and meir.inv.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 12:10
S48	4	junction and (thermoelectric$2 or Peltier) and meir.inv.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 12:12
S49	5	junction with temperature and meir.inv.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 12:13
S50	22	(CPU or processor or microprocessor) with (thermoelectric$2 or peltier) and (temperature with (hot and cold) with (sensor or sensing))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 12:48

S51	59	(chip or die or semiconductor) with (thermoelectric$2 or peltier) and (temperature with (hot and cold) with (sensor or sensing))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 12:57
S52	51	S51 not S50	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/10/31 12:57

10/31/08 4:11:48 PM